## HMC6787A\* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

## COMPARABLE PARTS 🖳

View a parametric search of comparable parts.

## **EVALUATION KITS**

• HMC6787ALC5A Evaluation Board

## **DOCUMENTATION**

#### **Data Sheet**

• HMC6787A Data Sheet

## REFERENCE MATERIALS -

#### **Quality Documentation**

 Package/Assembly Qualification Test Report: LC5, LC5A (QTR: 2014-00384 REV: 01)

## **DESIGN RESOURCES**

- HMC6787A Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

#### **DISCUSSIONS**

View all HMC6787A EngineerZone Discussions.

## SAMPLE AND BUY

Visit the product page to see pricing options.

## TECHNICAL SUPPORT 🖳

Submit a technical question or find your regional support number.

### DOCUMENT FEEDBACK 🖳

Submit feedback for this data sheet.

This page is dynamically generated by Analog Devices, Inc., and inserted into this data sheet. A dynamic change to the content on this page will not trigger a change to either the revision number or the content of the product data sheet. This dynamic page may be frequently modified.

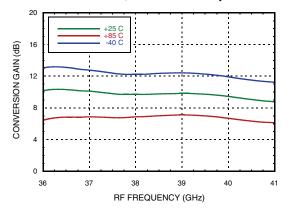




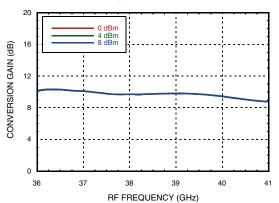
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

## Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 2350 MHz

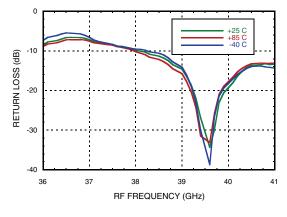
#### Conversion Gain, USB vs. Temperature



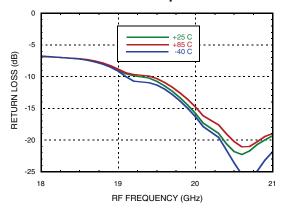
#### Conversion Gain, USB vs. LO Drive



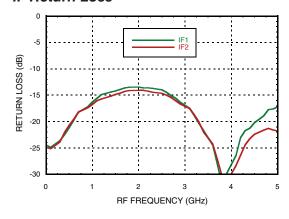
## RF Return Loss vs. Temperature



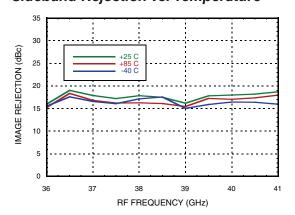
#### LO Return Loss vs. Temperature



#### IF Return Loss [1]



#### Sideband Rejection vs. Temperature



#### [1] Data taken without external IF 90° hybrid

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

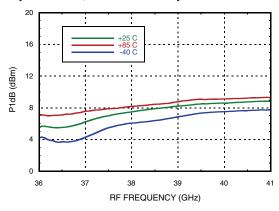




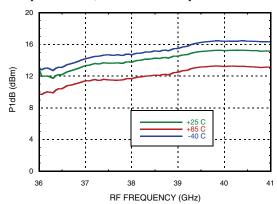
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

## Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 2350 MHz

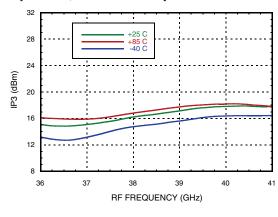
### Input P1dB, USB vs. Temperature



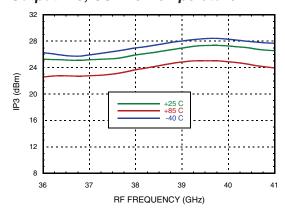
#### Output P1dB, USB vs. Temperature



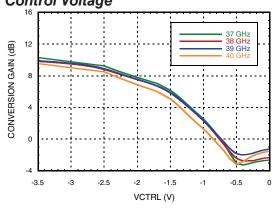
#### Input IP3, USB vs. Temperature



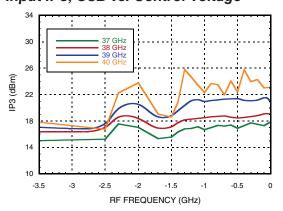
#### Output IP3, USB vs. Temperature



#### Conversion Gain, USB vs. **Control Voltage**



#### Input IP3, USB vs. Control Voltage



Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

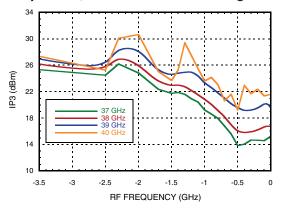




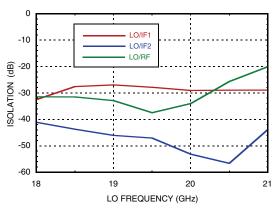
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

## Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 2350 MHz

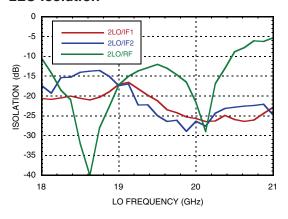
#### Output IP3, USB vs. Control Voltage



#### LO Isolation



#### **2LO** Isolation



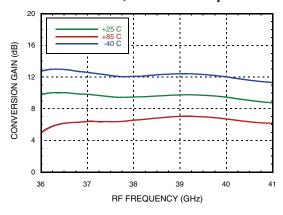




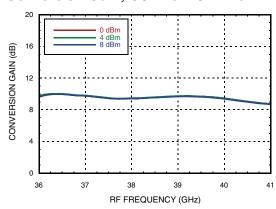
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

## Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 3000 MHz

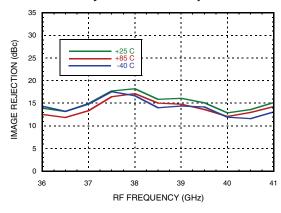
#### Conversion Gain, USB vs. Temperature



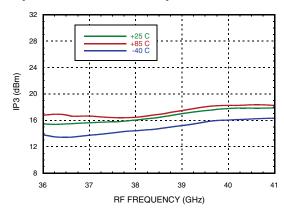
#### Conversion Gain, USB vs. LO Drive



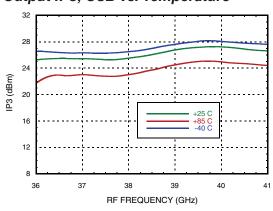
#### Sideband Rejection vs. Temperature



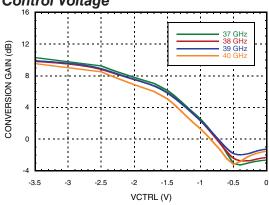
### Input IP3, USB vs. Temperature



#### Output IP3, USB vs. Temperature



Conversion Gain, USB vs. **Control Voltage** 



Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

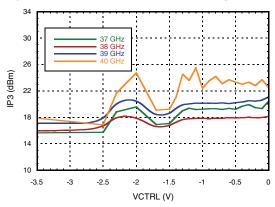




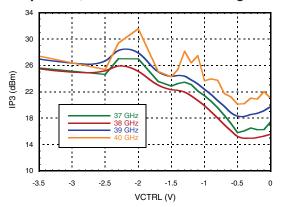
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 3000 MHz

#### Input IP3, USB vs. Control Voltage



#### Output IP3, USB vs. Control Voltage



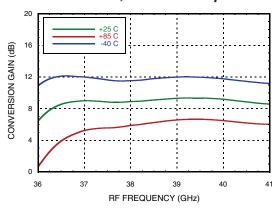




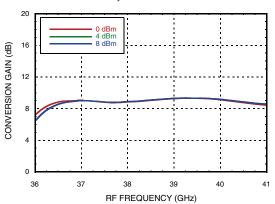
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

#### Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 3750 MHz

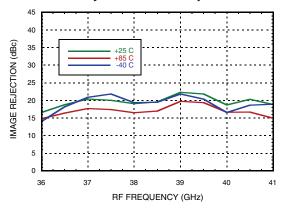
#### Conversion Gain, USB vs. Temperature



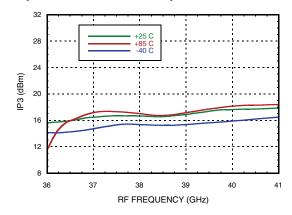
#### Conversion Gain, USB vs. LO Drive



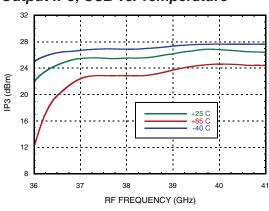
#### Sideband Rejection vs. Temperature



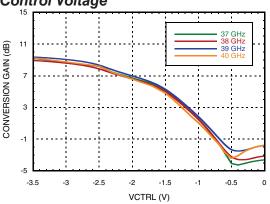
#### Input IP3, USB vs. Temperature



#### Output IP3, USB vs. Temperature



Conversion Gain, USB vs. Control Voltage



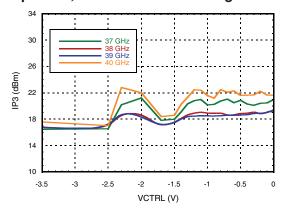


# RoHS

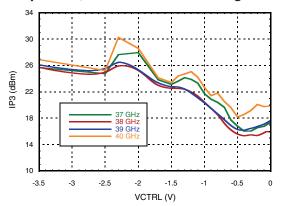
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

## Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 3750 MHz

#### Input IP3, LSB vs. Control Voltage



#### Output IP3, LSB vs. Control Voltage



<sup>[1]</sup> Data taken without external IF 90° hybrid

<sup>[2]</sup> All values in dBc below RF power level (2LO + IF) USB

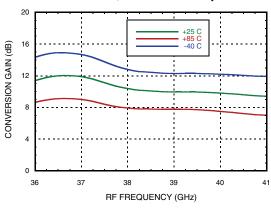


## RoHS

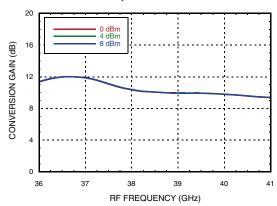
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

## Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 1000 MHz

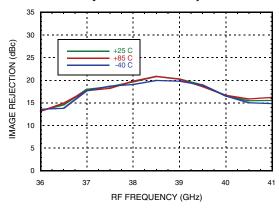
#### Conversion Gain, USB vs. Temperature



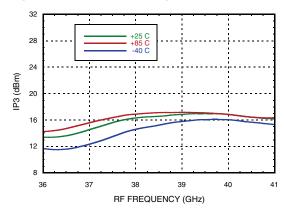
#### Conversion Gain, USB vs. LO Drive



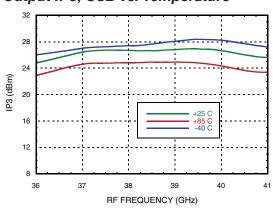
#### Sideband Rejection vs. Temperature



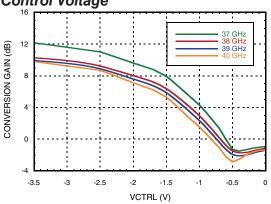
#### Input IP3, USB vs. Temperature



#### Output IP3, USB vs. Temperature



Conversion Gain, USB vs. Control Voltage



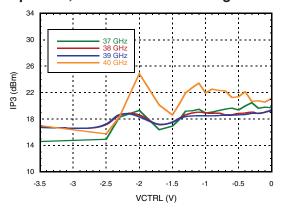


## RoHS V

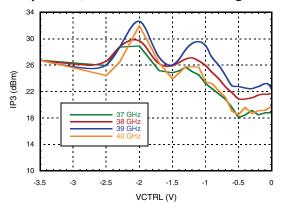
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 1000 MHz

#### Input IP3, LSB vs. Control Voltage



#### Output IP3, LSB vs. Control Voltage







## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

#### MxN Spurious Outputs [1][2]

	nLO				
mIF	0	1	2	3	4
0		31	4		
1	54	65	0		
2	62	71	40		
3	122	90	62		
4	122	122	122		
5	122	122	122		

IF = 2.35 GHz @ -8 dBm LO = 17.575 GHz @ +4 dBm

#### MxN Spurious Outputs [1][2]

	nLO				
mIF	0	1	2	3	4
0		32	5		
1	56	59	0		
2	59	79	64		
3	118	118	68		
4	118	118	118		
5	118	118	118		

IF = 3 GHz @ -8 dBm LO = 17.75 GHz @ +4 dBm

## MxN Spurious Outputs [1][2]

	nLO				
mIF	0	1	2	3	4
0		31	5		
1	56	51	0		
2	61	70	48		
3	118	84	58		
4	122	122	122		
5	122	122	122		

IF = 4 GHz @ -8 dBm LO = 17.75 GHz @ +4 dBm

## MxN Spurious Outputs [1][2]

	nLO				
mIF	0	1	2	3	4
0		34	4		
1	59	54	0		
2	71	72	39		
3	120	86	62		
4	120	122	120		
5	120	120	120		

IF = 1 GHz @ -8 dBm LO = 18.5 GHz @ +4 dBm

<sup>[1]</sup> Data taken without external IF 90° hybrid

<sup>[2]</sup> All values in dBc below RF power level (2LO + IF) USB





## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

Pin Descriptions

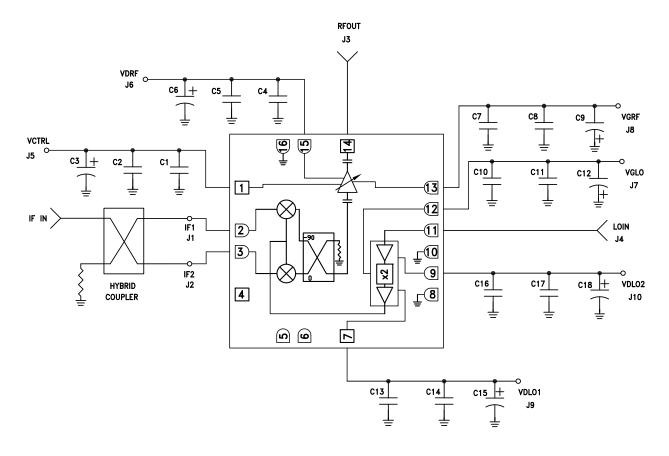
PIII Descripti	UIIS		
Pin Number	Function	Description	Interface Schematic
1	VCTRL	Vary Vctrl from -3.5V to 0V to adjust conversion gain.Maximum Gain occurs at -3.5V. Current draw << 1 mA.	Vetl O
2	IF1	Pins are DC coupled Must not source or sink more than	IF1,IF2 O
3	IF2	+/- 3 mA for applications requiring operation to DC.	¥ ‡
4, 5, 6	N/C	No connection required. The pins are not connected inter- nally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
7	VDLO1	Bias for multiplier input buffer amp. The recommended DC voltage is +3V.	VDL01,2
9	VDLO2	Bias for multiplier input buffer amp. The recommended DC voltage is +3V.	<u></u>
8, 10, 16	GND	These pins and package bottom must be connected to RF/DC ground.	→ GND =
11	LOIN	LO input port. The recommeded LO power is 0 to 8 dBm.	LOIN O
12	VGLO	Adjust VGLO for -1V to 0V to set the multiplier quiescent current to 150 mA ( 200 - 230 mA with LO Drive ).	VGLO =
13	VGRF	Adjust VGRF for -1V to 0V to set the VGA current to 200 mA.	VGRF
14	RFOUT	RF output port.	— —○ RFOUT
15	VDRF	Bias voltage for the VGA. The recommended DC voltage is +3V.	VDRF





## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

### **Typical Application**



C1, C4, C7, C10, C13, C16	100 pF Capacitor, 0402 Pkg.	
C2, C5, C8, C11, C14, C17	0.1 uF Capacitor, 0402 Pkg.	
C3, C6, C9, C12, C15, C18	4.7 μF Capacitor, Case A Pkg.	





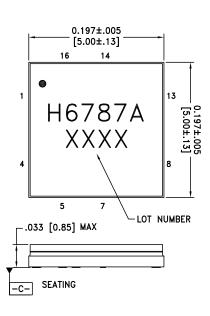
## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

### **Absolute Maximum Ratings**

IF Input	+20 dBm
LO Input	+10 dBm
Channel Temperature	175 °C
Continuous Pdiss (T = 85°C) (derate 18.3 mW/°C above 85°C)	1.65 W
Thermal Resistance (channel to ground paddle)	54.6 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class1A



#### **Outline Drawing**



#### **BOTTOM VIEW** .103 [2.62] .011 [0.27] TYP. 45 2 PL **EXPOSED PIN 16** .031 [0.80] GROUND REF **PADDLE** 00 PIN 1 0 .039 [1.00] [3.20] 138 [3.50] SQUARE [2.50] [2.50][3.30]4 PL Ø $\bigcirc$ Ø Œ. .126 130 980 .098 0 $\mathbb{Z}$ П .020 [0.50] Uaa 8 PL → .030 [0.77], 2 PL R.006 .012 [0.30] [R0.15] TYP -.047 [1.20], 2 PL 12 PL .010 [0.25], 4 PL .013 [0.32] 12 PL -.008 [0.20], TYP

#### NOTES

- PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING: 30 80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKLE
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

#### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC6787ALC5A	Alumina, White	Gold over Nickel	MSL3 <sup>[1]</sup>	6768A XXXX

<sup>[1]</sup> Max peak reflow temperature of 260 °C

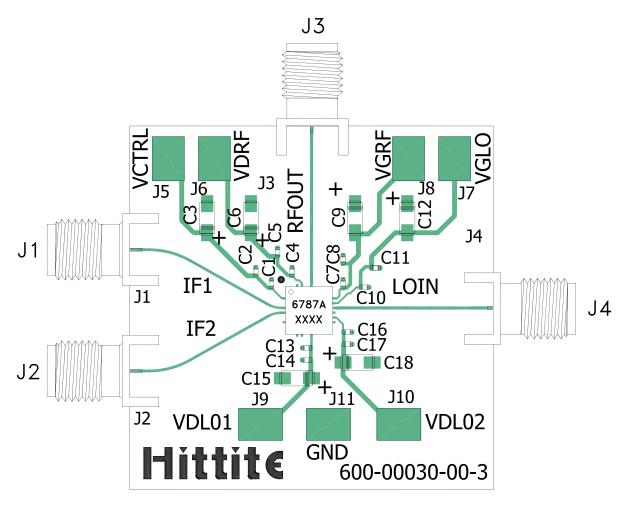
<sup>[2] 4-</sup>Digit lot number XXXX





## GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

#### **Evaluation PCB**



#### List of Materials for Evaluation PCB Eval01-HMC6787ALC5A [1]

Item	Description
J1, J2	SMA Connector
J3, J4	K-Connector SRI
J5 - J11	DC Pins
C1, C4, C7, C10, C13, C16	100 pF Capacitor, 0402 Pkg.
C2, C5, C8, C11, C14, C17	0.1 uF Capacitor, 0402 Pkg.
C3, C6, C9, C12, C15, C18	4.7 μF Capacitor, Case A
U1	HMC6787ALC5A Upconverter
PCB [2]	600-00030-00 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25FR, FR4 or Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.







**ANALOG**DEVICES

GaAs MMIC I/Q UPCONVERTER 37 - 40 GHz

Notes: